

# RL78 Family

## FFT Library: Deployment Guide

---

### Introduction

This document provides information for deploying FFT Library. Fast Fourier transform (FFT) is an algorithm that executes the discrete Fourier transform at high speed. The implementation developed in 1965 by James Cooley and John Tukey, now widely known as FFT, has contributed to the rapid advancement of digital signal processing applications.

The FFT library is provided in a version that has been tuned at the assembly language level to enable efficient processing on Renesas MCUs.

### Target Devices

RL78/G13, RL78/G14, RL78/G23

---

**Contents**

1. Product Configuration.....	3
2. Library Functions.....	4
3. CS+ for CC.....	5
3.1 Limitations.....	5
3.2 Compiler Options.....	5
3.3 Development Environment.....	5
3.4 ROM, RAM, and Stack Sizes.....	6
3.5 Section Information.....	6
3.6 Library Performance.....	6
3.7 Version Information.....	7
4. IAR Embedded Workbench.....	8
4.1 Compiler Options.....	8
4.2 Development Environment.....	8
4.3 ROM, RAM, and Stack Sizes.....	9
4.4 Section Information.....	9
4.5 Library Performance.....	9
4.6 Version Information.....	10
Revision History.....	11

## 1. Product Configuration

The product comprises the following items.

1. FFT Library V. 1.01 Release 00
2. FFT Library V. 1.01 Release 00: Deployment Guide (r20an0150ej0105\_rl78\_fft.pdf)  
Product No.: R0M7800LF0010RRC

The product comprises the files listed in Table 1.1.

**Table 1.1 FFT Library Configuration**

	Description
r20an0150ej0105_rl78_fft.pdf	Deployment guide (this document)
<b>Workspace (workspace)</b>	
<b>Documents (doc)</b>	
<b>English (en)</b>	
r20uw0099ej0102_fft.pdf	User's Manual
r20an0150ej0105_rl78_fft.pdf	Deployment guide (this document)
<b>Japanese (ja)</b>	
r20uw0099jj0102_fft.pdf	User's Manual
r20an0150jj0105_rl78_fft.pdf	Deployment guide
<b>CS+ for CC (CS+ for CC)</b>	
<b>FFT library (sample/&lt;sample program folder&gt;lib)</b>	
libfft_rl78g13.lib	FFT library for RL78/G13 (assembler version), version 1.01
libfft_rl78g14.lib	FFT library for RL78/G14 and RL78/G23 (assembler version), version 1.01
r_fft_int16.h	FFT library header file
r_stdint.h	Type definition header file
<b>Sample program (sample)</b>	
rl78g14_fft_ccrl_CS+	Sample CS+ for CC project (RL78/G14 and RL78/G23)
rl78g14_fft_ccrl_e2studio	Sample e2studio for CC project (RL78/G14 and RL78/G23)
<b>IAR Embedded Workbench (IAR)</b>	
<b>FFT library (sample/&lt;sample program folder&gt;lib)</b>	
libfft_rl78g14.a	FFT library for RL78/G14 and RL78/G23 (assembler version), version 1.01
r_fft_int16.h	FFT library header file
r_stdint.h	Type definition header file
<b>Sample program (sample)</b>	
rl78g14_fft_iar	Sample IAR Embedded Workbench project (RL78/G14 and RL78/G23)

## 2. Library Functions

The FFT library supports the following library functions (APIs).

API	Description
R_rfft64_int16	16-bit fixed-point real-number FFT (64 points)
R_rfft128_int16	16-bit fixed-point real-number FFT (128 points)
R_rfft256_int16	16-bit fixed-point real-number FFT (256 points)

### 3. CS+ for CC

#### 3.1 Limitations

The FFT library for the RL78/G13 uses the MCU's on-chip multiplier and divider/multiply-accumulator for multiply-accumulate operations. Therefore, it is necessary to ensure that the register values listed below are not changed within interrupt handlers implemented by the user. For information on the multiplier and divider/multiply-accumulator and related registers, refer to chapter 14, Multiplier and Divider/Multiply-Accumulator, in RL78/G13 User's Manual: Hardware.

Registers

- Multiplication/division data register A (L) (MDAL)
- Multiplication/division data register A (H) (MDAH)
- Multiplication/division data register B (L) (MDBL)
- Multiplication/division data register B (H) (MDBH)
- Multiplication/division data register C (L) (MDCL)
- Multiplication/division data register C (H) (MDCH)

Control register

- Multiplication/division control register (MDUC)

#### 3.2 Compiler Options

The library files are generated using the following compile options.

[Compile options]

```
-asmopt=-mirror_source=common -memory_model=medium
```

#### 3.3 Development Environment

The Renesas development environment consists of the items listed below.

Make sure to use the latest versions available when developing user applications.

[Software tools]

- Integrated development environment  
CS+ for CC V8.06.00
- C compiler  
CC-RL V1.10
- Debugger  
RL78 simulator

### 3.4 ROM, RAM, and Stack Sizes

The ROM, RAM, and stack sizes of the various FFT library APIs are listed below (unit: bytes).

FFT library for RL78/G13:

API	ROM	RAM	Stack
R_rfft64_int16	1,260	0	68
R_rfft128_int16	1,512	0	68
R_rfft256_int16	2,018	0	68

FFT library for RL78/G14 and RL78/G23:

API	ROM	RAM	Stack
R_rfft64_int16	1,224	0	68
R_rfft128_int16	1,476	0	68
R_rfft256_int16	1,982	0	68

### 3.5 Section Information

The sections (segments) used by the various FFT library APIs are listed in the table below.

Section Name	Description	Section Attribute
.textf	Program	.CSEG TEXTF
.const	Constant data	.CSEG CONST

### 3.6 Library Performance

The processing times when calling the various library functions (APIs) are listed below.

FFT library for RL78/G13:

API	Time (System Clock = 32 MHz)
R_rfft64_int16	Approx. 0.4 ms
R_rfft128_int16	Approx. 0.9 ms
R_rfft256_int16	Approx. 1.9 ms

FFT library for RL78/G14 and RL78/G23:

API	Time (System Clock = 32 MHz)
R_rfft64_int16	Approx. 0.3 ms
R_rfft128_int16	Approx. 0.7 ms
R_rfft256_int16	Approx. 1.6 ms

Measured using the execution time measurement function of the integrated development environment (CS +)

### 3.7 Version Information

The version information for the library is stored as a character string in the `r_fft_a_version` variable. This variable can be accessed by means of the following extern declaration.

```
Extern const char r_fft_a_version[];
```

The data stored in the libraries comprising the current product is shown below.

FFT library for RL78/G13:

```
const char r_fft_a_version[] =  
"FFT Library version 1.01 for RL78 Family (RL78G13) (Dec 7 2015, 17:30:04)";
```

FFT library for RL78/G14 and RL78/G23:

```
const char r_fft_a_version[] =  
"FFT Library version 1.01 for RL78 Family (RL78G14) (Dec 7 2015, 17:29:42)";
```

## 4. IAR Embedded Workbench

### 4.1 Compiler Options

The library files are generated using the following compile options.

[Compile options]

```
__FAR_MODEL__ __NEAR_DATA_MODEL__  
NDEBUG __RL78__ __TARGET__=RL78G14
```

### 4.2 Development Environment

The Renesas development environment consists of the items listed below.

Make sure to use the latest versions available when developing user applications.

[Software tools]

- Integrated development environment  
IAR Embedded Workbench for Renesas RL78 4.21.1
- C compiler  
IAR C/C++ Compiler for Renesas RL78 4.21.1.2409
- Debugger  
IAR C-SPY Debugger Kernel 8.5.2.7561



### 4.3 ROM, RAM, and Stack Sizes

The ROM, RAM, and stack sizes of the various FFT library APIs are listed below (unit: bytes).

FFT library for RL78/G14 and RL78/G23:

API	ROM	RAM	Stack
R_rfft64_int16	1,226	0	68
R_rfft128_int16	1,478	0	68
R_rfft256_int16	1,984	0	68

### 4.4 Section Information

The sections (segments) used by the various FFT library APIs are listed in the table below.

Section Name	Description
.textf	Program
.const	Constant data

### 4.5 Library Performance

The processing times when calling the various library functions (APIs) are listed below.

FFT library for RL78/G14 and RL78/G23:

API	Time (System Clock = 32 MHz)
R_rfft64_int16	Approx. 0.2 ms
R_rfft128_int16	Approx. 0.6 ms
R_rfft256_int16	Approx. 1.5 ms

Measured using the execution time measurement function of the integrated development environment (IAR Embedded Workbench for Renesas RL78))

## 4.6 Version Information

The version information for the library is stored as a character string in the `r_fft_a_version` variable. This variable can be accessed by means of the following extern declaration.

```
Extern const char r_fft_a_version[];
```

The data stored in the libraries comprising the current product is shown below.

FFT library for RL78/G14 and RL78/G23:

```
const char r_fft_a_version[] =  
"FFT Library version 1.01 for RL78 Family (RL78G14) (Sep  7 2021, 13:40:39)";
```

**Revision History**

Rev.	Date	Description	
		Page	Summary
1.00	Mar. 31, 2012	—	First edition issued
1.01	Apr. 1, 2014	—	Updated product configuration to match package version V. 1.00 Release 01. Added support for IAR Embedded Workbench.
1.02	Apr. 1, 2015	2	Updated product configuration to match package version V. 1.00 Release 02.
1.03	Oct. 1, 2015	—	Changed CubeSuite+ to CS+ for CA and CX. Added support for CS+ for CC.
1.04	Apr. 13, 2021	—	Added RL78/G23 to CS+ for CC. Deleted IAR.
1.05	Oct. 25, 2021	P6 P8-P10	Remove CS + for CA, CX Updated the processing time of FFT library for RL78/G14 and RL78/G23 Add IAR

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

## 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

## 2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

## 3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

## 4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

## 5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

## 6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

## 7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

## 8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

## Notice

1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information.
2. Renesas Electronics hereby expressly disclaims any warranties against and liability for infringement or any other claims involving patents, copyrights, or other intellectual property rights of third parties, by or arising from the use of Renesas Electronics products or technical information described in this document, including but not limited to, the product data, drawings, charts, programs, algorithms, and application examples.
3. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
4. You shall be responsible for determining what licenses are required from any third parties, and obtaining such licenses for the lawful import, export, manufacture, sales, utilization, distribution or other disposal of any products incorporating Renesas Electronics products, if required.
5. You shall not alter, modify, copy, or reverse engineer any Renesas Electronics product, whether in whole or in part. Renesas Electronics disclaims any and all liability for any losses or damages incurred by you or third parties arising from such alteration, modification, copying or reverse engineering.
6. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The intended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.

"Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; industrial robots; etc.

"High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control (traffic lights); large-scale communication equipment; key financial terminal systems; safety control equipment; etc.

Unless expressly designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not intended or authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems; surgical implantations; etc.), or may cause serious property damage (space system; undersea repeaters; nuclear power control systems; aircraft control systems; key plant systems; military equipment; etc.). Renesas Electronics disclaims any and all liability for any damages or losses incurred by you or any third parties arising from the use of any Renesas Electronics product that is inconsistent with any Renesas Electronics data sheet, user's manual or other Renesas Electronics document.
7. No semiconductor product is absolutely secure. Notwithstanding any security measures or features that may be implemented in Renesas Electronics hardware or software products, Renesas Electronics shall have absolutely no liability arising out of any vulnerability or security breach, including but not limited to any unauthorized access to or use of a Renesas Electronics product or a system that uses a Renesas Electronics product. RENESAS ELECTRONICS DOES NOT WARRANT OR GUARANTEE THAT RENESAS ELECTRONICS PRODUCTS, OR ANY SYSTEMS CREATED USING RENESAS ELECTRONICS PRODUCTS WILL BE INVULNERABLE OR FREE FROM CORRUPTION, ATTACK, VIRUSES, INTERFERENCE, HACKING, DATA LOSS OR THEFT, OR OTHER SECURITY INTRUSION ("Vulnerability Issues"). RENESAS ELECTRONICS DISCLAIMS ANY AND ALL RESPONSIBILITY OR LIABILITY ARISING FROM OR RELATED TO ANY VULNERABILITY ISSUES. FURTHERMORE, TO THE EXTENT PERMITTED BY APPLICABLE LAW, RENESAS ELECTRONICS DISCLAIMS ANY AND ALL WARRANTIES, EXPRESS OR IMPLIED, WITH RESPECT TO THIS DOCUMENT AND ANY RELATED OR ACCOMPANYING SOFTWARE OR HARDWARE, INCLUDING BUT NOT LIMITED TO THE IMPLIED WARRANTIES OF MERCHANTABILITY, OR FITNESS FOR A PARTICULAR PURPOSE.
8. When using Renesas Electronics products, refer to the latest product information (data sheets, user's manuals, application notes, "General Notes for Handling and Using Semiconductor Devices" in the reliability handbook, etc.), and ensure that usage conditions are within the ranges specified by Renesas Electronics with respect to maximum ratings, operating power supply voltage range, heat dissipation characteristics, installation, etc. Renesas Electronics disclaims any and all liability for any malfunctions, failure or accident arising out of the use of Renesas Electronics products outside of such specified ranges.
9. Although Renesas Electronics endeavors to improve the quality and reliability of Renesas Electronics products, semiconductor products have specific characteristics, such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Unless designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not subject to radiation resistance design. You are responsible for implementing safety measures to guard against the possibility of bodily injury, injury or damage caused by fire, and/or danger to the public in the event of a failure or malfunction of Renesas Electronics products, such as safety design for hardware and software, including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult and impractical, you are responsible for evaluating the safety of the final products or systems manufactured by you.
10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. You are responsible for carefully and sufficiently investigating applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive, and using Renesas Electronics products in compliance with all these applicable laws and regulations. Renesas Electronics disclaims any and all liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
11. Renesas Electronics products and technologies shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You shall comply with any applicable export control laws and regulations promulgated and administered by the governments of any countries asserting jurisdiction over the parties or transactions.
12. It is the responsibility of the buyer or distributor of Renesas Electronics products, or any other party who distributes, disposes of, or otherwise sells or transfers the product to a third party, to notify such third party in advance of the contents and conditions set forth in this document.
13. This document shall not be reprinted, reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
14. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products.

(Note1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its directly or indirectly controlled subsidiaries.

(Note2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

(Rev.5.0-1 October 2020)

## Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,  
Koto-ku, Tokyo 135-0061, Japan

[www.renesas.com](http://www.renesas.com)

## Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

## Contact information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit:

[www.renesas.com/contact/](http://www.renesas.com/contact/).